

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ITARU FURUKAWA	12/24/2013
HIROSHI SANO	01/06/2014
RECEIVING PARTY DATA	
Name:	DAINIPPON SCREEN MFG. CO., LTD.
Street Address:	TENJINKITA-MACHI 1-1, TERANOUCHE-AGARU 4-CHOME
Internal Address:	HORIKAWA-DORI, KAMIGYO-KU
City:	KYOTO-SHI, KYOTO
State/Country:	JAPAN
Postal Code:	602-8585
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14207232
CORRESPONDENCE DATA	
Fax Number:	(202)756-8087
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-756-8000
Email:	IPDOCKETMWE@MWE.COM
Correspondent Name:	MCDERMOTT WILL & EMERY LLP
Address Line 1:	THE MCDERMOTT BUILDING
Address Line 2:	500 NORTH CAPITOL STREET, N.W.
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20001
ATTORNEY DOCKET NUMBER:	065326-0121
NAME OF SUBMITTER:	STEPHEN A., BECKER
SIGNATURE:	/STEPHEN A. BECKER/
DATE SIGNED:	03/12/2014
Total Attachments: 1	
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(SAB)

Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Itaru FURUKAWA (4) _____
- (2) Hiroshi SANO (5) _____
- (3) _____ (6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

DAINIPPON SCREEN MFG. CO., LTD. of Tenjinkita-machi 1-1, Teranouchi-agaru 4-chome,
Horikawa-dori, Kamigyo-ku, Kyoto-shi, Kyoto 602-8585, Japan

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

Ejection Inspection Apparatus and Substrate Processing Apparatus

(a) for which an application for United States Letters Patent was filed on _____
and identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____.

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u>Itaru Furukawa</u> Name: Itaru FURUKAWA	<u>Dec. 24, 2013</u>
2) <u>Hiroshi Sano</u> Name: Hiroshi SANO	<u>Jan. 06, 2014</u>
3) _____ Name: _____	_____
4) _____ Name: _____	_____
5) _____ Name: _____	_____
6) _____ Name: _____	_____